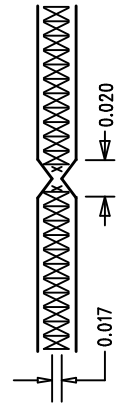


LAYER 1 (COMPONENT SIDE)
 LAYER 2 (GND)
 LAYER 3 (GND)
 LAYER 4 (SOLDER SIDE)

NOTES : Unless Otherwise Specified

PCBs ARE TO BE RoHS COMPLIANT

1. MATERIAL : FR4 OR EQUIVALENT EPOXY
2 OZ OUTER, 1 OZ INNER COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
GOLD IMMERSION BOTH SIDES.
SOLDER MASK OVER BARE COPPER (SMB0C)
3. SOLDER MASK : BOTH SIDES USING GREEN LPI OR EQUIVALENT
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. ALL DIMENSIONS ARE IN INCHES
6. SCORING (FOR PRODUCTION RUN)



7. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE.
BUT YOU MAY MODIFY PAD SIZE TO MEET END FINISH

Fabrication Drawing

APPROVALS						LINEAR TECHNOLOGY	
		INIT	DATE				
CHECK	DRAWN						
DESIGN		Antonio					
ENGR		Victor Kh.					
				TITLE: LTC3545EUD			
				TRIPLE DC/DC CONVERTER			
		SIZE	NONE	Demo Circuit 1193A		REV. 3	
SCALE = NONE				DES-23xxxx		SHT 1 of 1	